

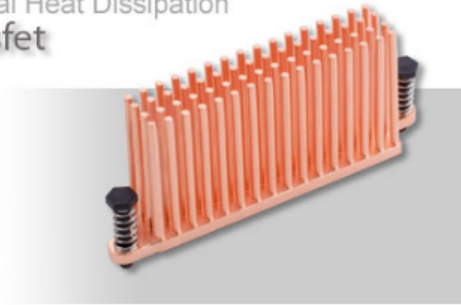
Heat Sink



Specification

- 1. Material: CU 1100
- 2. Dimension:
 - Foot print: 72*13 mm
 - Height: 29.6 mm
 - Base(thickness): 2.6 mm
- 3. Finish: Redox

MST-66
 Exceptional Heat Dissipation
 For Mosfet



Performance

Heat Source (L*W)	48*11
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